PCN Number: 2016123		201612300	230001			PCN Date:			Jan	Jan. 6, 2017		
Title	e: Datasheet fo	r LDC1101										
	tomer Contact:	PCN Manager					D	ер	t:	Quality Services		
Cha	nge Type:									, -		
	Assembly Site			Design] [Wafer	Bump Site		
	Assembly Process		\boxtimes	Data Shee				_		Bump Material		
	Assembly Materials			Part number change				_	Wafer Bump Process			
Mechanical Specification			뷔	Test Site					Wafer Fab Site			
Packing/Shipping/Labeling			Ш	Test Process			┢	-	Wafer Fab Materials Wafer Fab Process			
			No	otificatio	n Deta	ils		<u> </u>	water	rab Process		
Des	cription of Chang	je:		Jenneario	II Deta	11.5						
	as Instruments Inc		ann	ouncing an	informa	tion on	ly n	ot	ificatio	on.		
The	product datasheet	(s) is being u	pda	ited as sum	ımarized	below.						
The	following change h	istory provid	es f	further deta	ils.							
J	/ Texas											
•	TEXAS INSTRUMENTS					SNOSDO	1D_N	MΔV	2015_PEV	LDC1101 ISED OCTOBER 2018		
_						SNOSDU	ID-N	WAT.	2013-REV	ISED OCTOBER 2010		
Cha	anges from Revision C (Fe	ebruary 2016) to R	levisi	ion D						Page		
	Added link to Application Note SNOA944								12			
	Changed RPMAX_DIS field											
 Changed location of notes detailing register read sequence from inside field entry in table to paragraph under 												
	register title											
	Changed Field R/W value to R/W											
Added clarification on L-only mode or RP+L mode in example configu												
	Changed incorrect value in table											
	datasheet number	will be chang	ging	·								
	Device Family			Change F						Change To:		
LD	LDC1101			SNOSD01C				SNOSD01D				
	se changes may be ://www.ti.com/pro			datasheet	links pro	vided.						
Rea	son for Change:											
To n	nore accurately ref	lect device ch	nara	cteristics.								
Anti	icipated impact o	n Fit, Form,	Fu	ınction, Qເ	uality or	Relial	bili	ty	(posi	tive / negative):		
	anticipated impact. ne actual device.	This is a spe	cific	cation chang	ge annoi	ınceme	ent	on	ly. The	ere are no changes		
Changes to product identification resulting from this PCN:												
Non	<u> </u>			_								
Pro	duct Affected:											
LD	C1101DRCR	LDC1101D	RC	 Т								

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com